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General Description

The AA4005 is a Class AB audio power amplifier which can deliver 2.7W into 3Ω speakers with 5.0V power supply and THD+N less than 10%. It is designed specially for Notebook PC and portable media player applications.

The AA4005 features stereo full differential input or 2 sets of stereo Single-Ended audio input. There are 4 different gain settings at BTL mode - 6dB, 10dB, 15.6dB and 21.6dB, changed by setting GAIN0, GAIN1 pins.

AA4005 is available in TSSOP-20 (EDP) package.

Features

- Output Power, THD+N=10%
 1.5W at BTL Mode for 8Ω Speaker
 2.3W at BTL Mode for 4Ω Speaker
 2.7W at BTL Mode for 3Ω Speaker
- Supply Voltage Range: 4.5V to 5.5V
- 4 Selectable Internal Fixed Gain Setups
- Stereo Full Differential Input
- Low Power Consumption at Shutdown Mode 150μA Typical
- Excellent Click/POP Noise Suppression
- Thermal Shutdown Protection

Applications

- · Notebook PC
- Portable Media Player

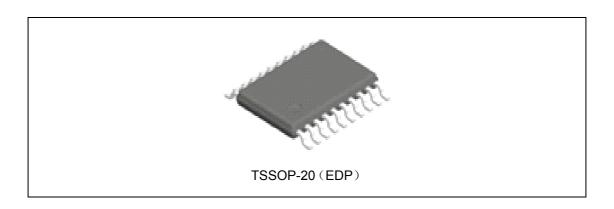


Figure 1. Package Type of AA4005



Pin Configuration

G Package (TSSOP-20 (EDP))

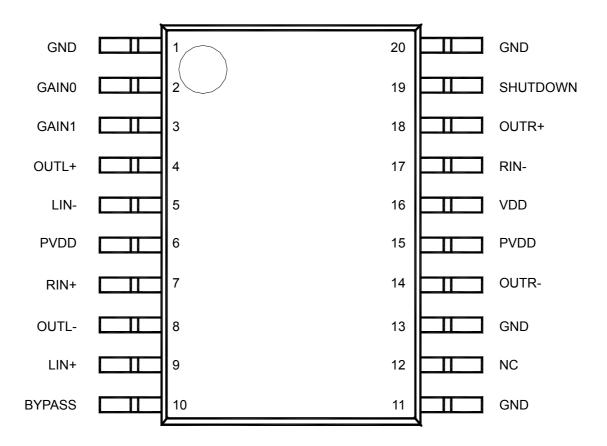


Figure 2. Pin Configuration of AA4005 (Top View)



Pin Description

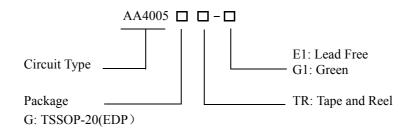
PIN Number	PIN Name	Function
1, 11, 13, 20	GND	Ground reference, it is better to connect with thermal pad.
2	Gain0	Internal gain setup 0, see table-1 below.
3	Gain1	Internal gain setup 1, see table-1 below.
4	OUTL+	Left channel positive output
5	LIN-	Left channel negative input
6, 15	PVDD	Power supply for output stage
7	RIN+	Right channel positive input for differential input, AC ground for Single-ended input.
8	OUTL-	Left channel negative output
9	LIN+	Left channel positive input for differential input, AC ground for Single-ended input
10	BYPASS	Internal reference voltage pin, connect a 1.0µF ceramic capacitor to GND
12	NC	No connected
14	OUTR-	Right channel negative output
16	VDD	Power supply for analog circuit
17	RIN-	Right channel negative input
18	OUTR+	Right channel positive output
19	SHUTDOWN	Shutdown mode select, L - Shutdown enable H - Shutdown disable, normal work



Table-1, Gain vs. Gain0, Gain1 Logic level

GAIN0	GAIN1	Gain
L	L	6dB
L	Н	10dB
Н	L	15.6dB
Н	Н	21.6dB

Ordering Information



Package	Temperature	Part N	umber	Marking ID		Packing Type	
	Range	Lead Free	Green	Lead Free	Green	racking Type	
TSSOP-20(EDP)	-40 to 85°C	AA4005GTR-E1	AA4005GTR-G1	AA4005G	AA4005G-G1	Tape and Reel	

BCD Semiconductor's Pb-free products, as designated with "E1" suffix in the part number, are RoHS compliant. Products with "G1" suffix are available in green packages.



Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Value	Unit
Power Supply Voltage	V _{DD}	6.0	V
Input Voltage	V _{IN}	-0.3 to V _{DD} +0.3	V
Power Dissipation (Note 2)	P_{D}	Internally limited	
Thermal Resistance	θ_{JA}	35 (Note 3)	°C/W
Operating Junction Temperature	T_{J}	150	°C
ESD (Machine Mode)		200	V
ESD (Human Body Mode)		2000	V
Storage Temperature Range	T _{STG}	-65 to 150	°C
Lead Temperature (Soldering, 10 Seconds)	T _{LEAD}	260	°C

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Note 2: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} and the ambient temperature T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA}$. For the AA4005, $T_{JMAX} = 150^{\circ}$ C, and the typical junction-to-ambient thermal resistance for TSSOP-20 (EDP) package can be found in the **Absolute Maximum Ratings** section.

Note 3: Chip is soldered to 60mm² (4mm×15mm) copper (top side solder mask) of 1oz. on PCB with 8×0.5mm vias.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Input Voltage	V_{DD}	4.5	5.5	V
Operating Ambient Temperature Range	$T_{\mathbf{A}}$	-40	85	°C



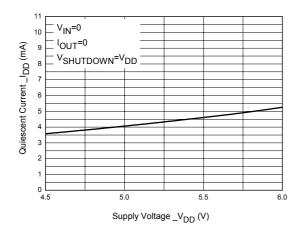
Electrical Characteristics

 $V_{DD}\!\!=\!\!5.0V, Gain\!\!=\!\!6dB, T_{A}\!\!=\!\!25^{o}C, f\!\!=\!\!1kHz, 22kHz \ Low \ pass \ filter, unless \ otherwise \ specified.$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Quiescent Current	I_{DD}	V _{IN} =0, I _O =0		6.5	12	mA
Shutdown Current	I_{SD}	V _{SHUTDOWN} =0		150	300	μΑ
	V_{IL}				0.8	V
SHUTDOWN	V_{IH}		2.0			V
Thermal Shutdown Temperature				165		°C
Hysteresis Temp Window				35		°C
Output Offset Voltage		V _{IN} =0, No load		±5	±25	mV
	P _O	THD+N=1%, R_L =3 Ω ,		2.1		W
		THD+N=10%, R_L =3 Ω ,		2.7		W
		THD+N=1%, R_L =4Ω,		1.8		W
Output Power		THD+N=10%, R_L =4 Ω ,		2.3		W
		THD+N=1%, R_L =8 Ω		1.2		W
		THD+N=10%, R_L =8 Ω		1.5		W
Total Harmonic Distortion Plus Noise	THD+N	$P_{O}=1W$, $R_{L}=4\Omega$		0.08		%
Signal to Noise Ratio	S/N	$P_O=1W$, $R_L=4\Omega$		100		dB
Cross Talk	X _{TALK}	f=1kHz		-100		dB
Power Supply Rejection Ration	PSRR	C _b =1μF, f=1kHz, V _{ripple} =0.2V _{RMS}		70		dB
Output Noise	V _{NO}	f =20Hz~20kHz, R_L =8 $Ω$		18		μV_{RMS}



Typical Performance Characteristics



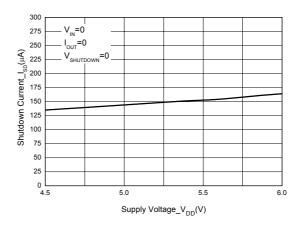
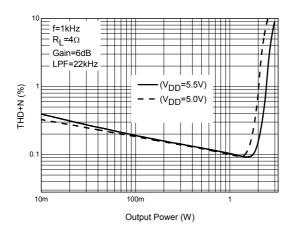


Figure 3. Quiescent Current vs. Supply Voltage

Figure 4. Shutdown Current vs. Supply Voltage



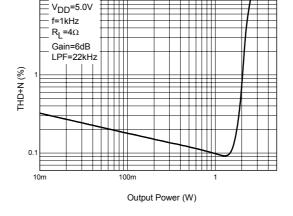
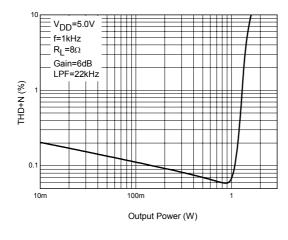


Figure 5. THD+N vs. Output Power

Figure 6. THD+N vs. Output Power



Typical Performance Characteristics (Continued)



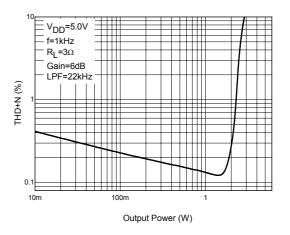
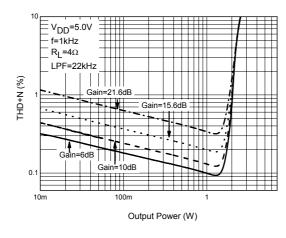


Figure 7. THD+N vs. Output Power

Figure 8. THD+N vs. Output Power



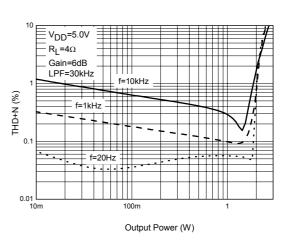
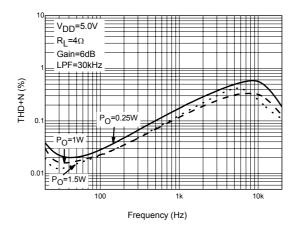


Figure 9. THD+N vs. Output Power

Figure 10. THD+N vs. Output Power



Typical Performance Characteristics (Continued)



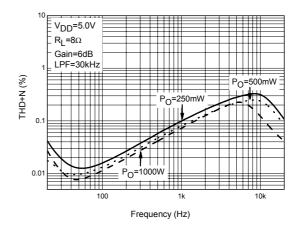
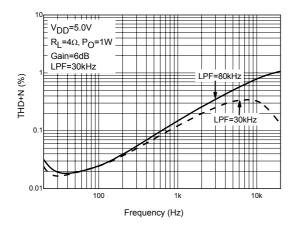


Figure 11. THD+N vs. Frequency

Figure 12. THD+N vs. Frequency





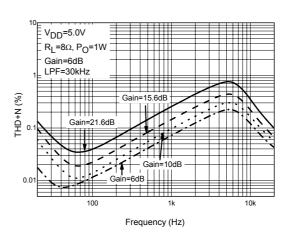
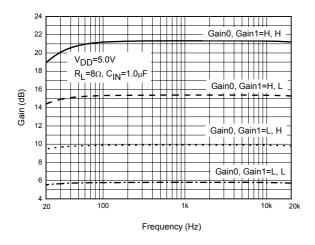


Figure 14. THD+N vs. Frequency



Typical Performance Characteristics (Continued)



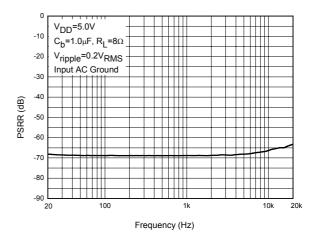


Figure 15. Gain vs. Frequency

Figure 16. PSRR vs. Frequency

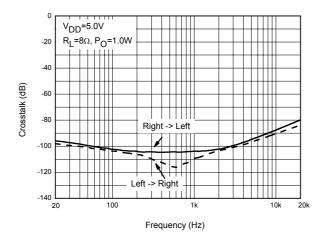


Figure 17. Crosstalk vs. Frequency



Typical Application

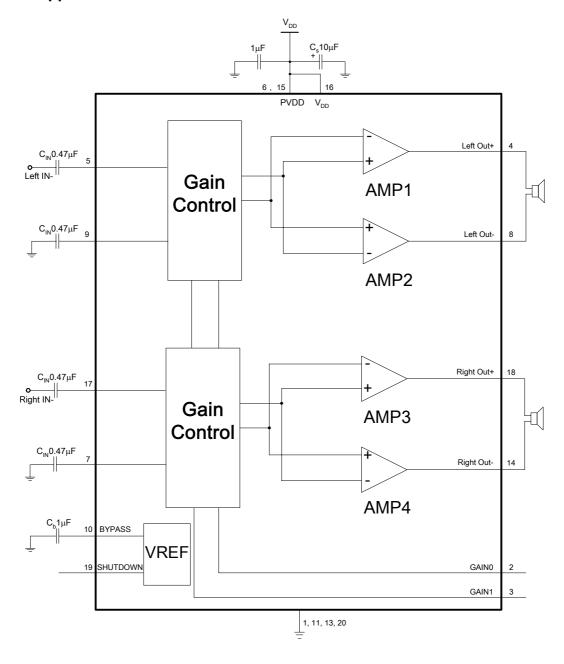


Figure 21. Typical Application of AA4005 for Single-ended input



Typical Application (Continued)

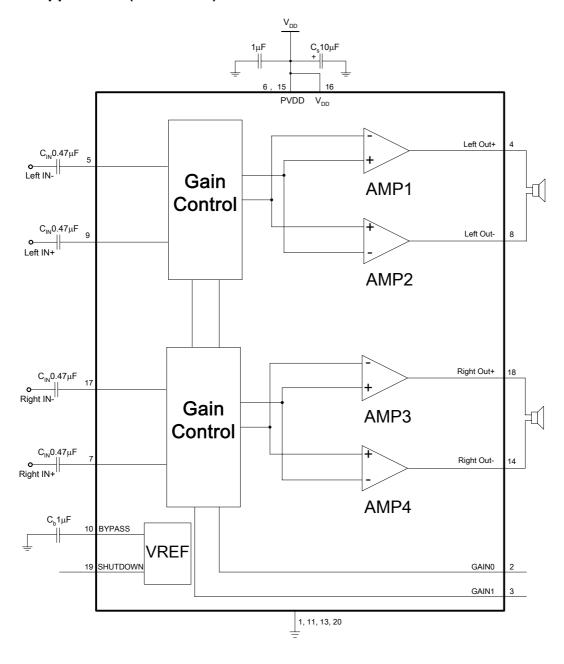
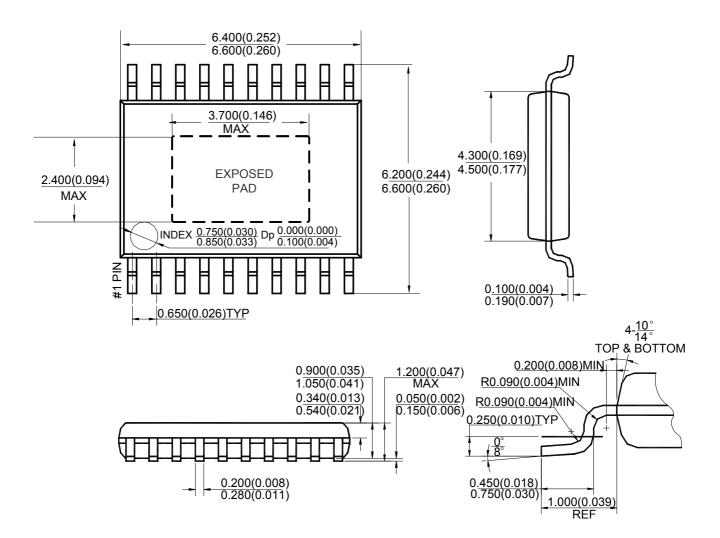


Figure 22. Typical Application of AA4005 for full differential input



Mechanical Dimensions

TSSOP-20(EDP) Unit: mm(inch)







BCD Semiconductor Manufacturing Limited

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